

Silicon Carbide Power Schottky Diode

Features

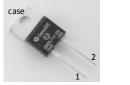
- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_{F}
- Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

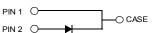
Advantages

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- · Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

Package

RoHS Compliant





TO - 220AC

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

Maximum Ratings at T_j = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	V _{RRM}		1200	V	
Continuous forward current	I _F	T _c ≤ 160 °C	2	А	
RMS forward current	F(RMS)	T _c ≤ 160 °C	3	А	
Surge non-repetitive forward current, Half Sine	e I _{F,SM}	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	18	•	
Wave		$T_{\rm C}$ = 160 °C, $t_{\rm P}$ = 10 ms	15	A	
Non-repetitive peak forward current	I _{F,max}	T _C = 25 °C, t _P = 10 μs	100	А	
² t value	∫i² dt	T _C = 25 °C, t _P = 10 ms	1.6	A ² s	
tvalue	ji at	T _C = 160 °C, t _P = 10 ms	1.1		
Power dissipation	P _{tot}	T _C = 25 °C	65	W	
Operating and storage temperature	T _j , T _{stg}		-55 to 175	°C	

Electrical Characteristics at T_j = 175 °C, unless otherwise specified

Devemeter	Symphol	Conditionsmi		Values		11	
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	VF	$I_{F} = 2 \text{ A}, \text{T}_{j} = 25 ^{\circ}\text{C}$		1.5	1.8	V	
		I _F = 2 A, T _j = 175 °C		2.6	3.0	-	
Reverse current	I _R	V _R = 1200 V, T _j V _R = 1200 V, T _j =			5 10	50 100	μA
Total capacitive charge	Qc	$ _{F} \leq _{F,MAX}$	V _R = 400 V V _R = 960 V		9 14		nC
Switching time	t _s	− dl _F /dt = 200 A/μs T _j = 175 °C	V _R = 400 V V _R = 960 V		< 17		ns
Total capacitance	С	$V_R = 1 V, f = 1 MHz$ $V_R = 400 V, f = 1 MHz$ $V_R = 1000 V, f = 1 MHz$	z, T _j = 25 °C		131 12 8		pF
Thermal Characteristics							
Thermal resistance, junction - case	R _{thJC}				2.3		°C/W

Mechanical Properties

moonamoarrioportioo			
Mounting torque	Μ	0.6	Nm

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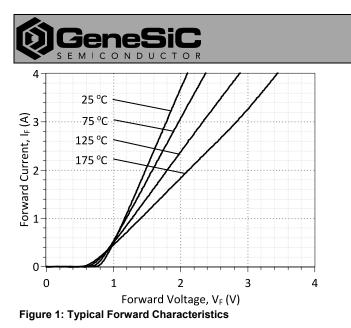
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VRRM

I_{F (Tc = 25°C)} Q_C 1200 V

5 A

9 nC



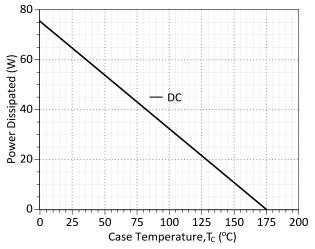
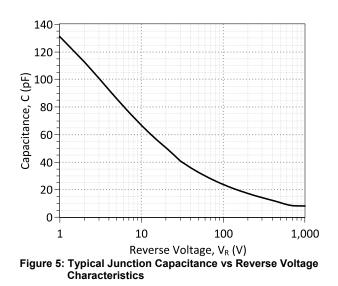
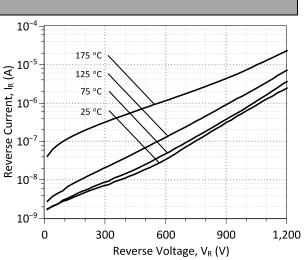


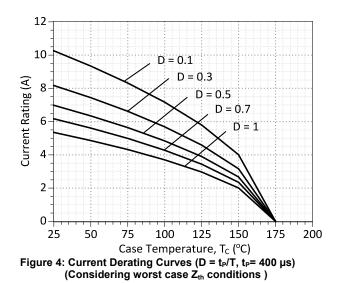
Figure 3: Power Derating Curve

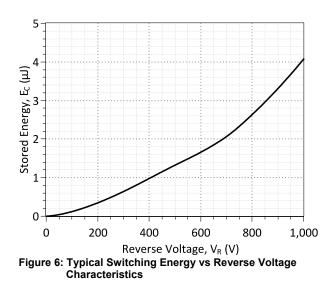


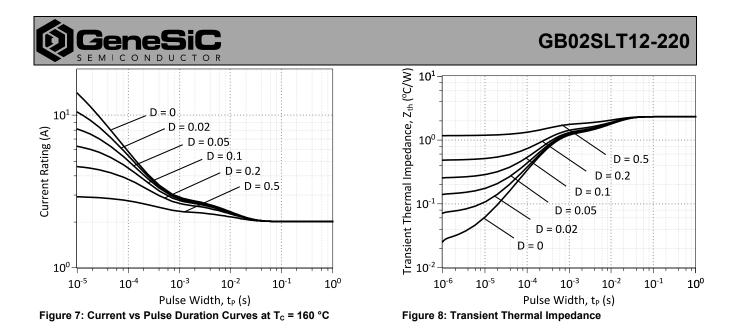


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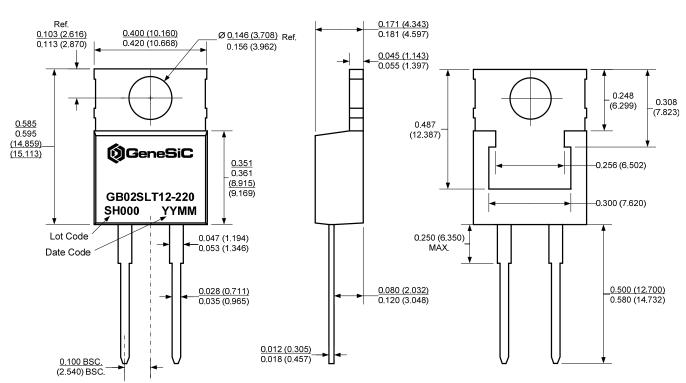
Figure 2: Typical Reverse Characteristics







Package Dimensions:



TO-220AC

PACKAGE OUTLINE

NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.

2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



GB02SLT12-220

Revision History				
Date	Revision	Comments	Supersedes	
2014/08/26	4	Updated Electrical Characteristics		
2013/06/12	3	Updated Electrical Characteristics		
2012/12/18	2	Second generation update		
2012/05/22	1	Second generation release		
2010/12/13	0	Initial release		

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the GB02SLT12-220 device.

```
*
     MODEL OF GeneSiC Semiconductor Inc.
*
*
    $Revision: 1.0
                              $
*
    $Date: 04-SEP-2013
                              $
*
*
    GeneSiC Semiconductor Inc.
*
    43670 Trade Center Place Ste. 155
*
    Dulles, VA 20166
*
   http://www.genesicsemi.com/index.php/sic-products/schottky
*
*
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* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB02SLT12-220 SPICE Model
.SUBCKT GB02SLT12 ANODE KATHODE
D1 ANODE KATHODE GB02SLT12
D2 ANODE KATHODE GB02SLT12 PIN
.MODEL GB02SLT12 D
                     RS
TRS2
     2.05E-15
                                 0.282
+ IS
        0.0054
+ TRS1
                                   3E-05
+ N
         1
                        IKF
                                  251
                        XTI
         1.2
+ EG
                                   -1.8
+ CJO
        1.61E-10
                       VJ
                                  0.4508
                        FC
+ M
         1.586
                                   0.5
        1.00E-10
1.00E-03
                       BV
+ TT
                                   1200
+ IBV
                        VPK
                                  1200
+ IAVE
                                  SiC Schottky
         2
                         TYPE
+ MFG GeneSiC_Semi
.MODEL GB02SLT12 PIN D
                       RS
         1.54E-25
                                  0.39
+ IS
        -0.003
+ TRS1
                        Ν
                                   3.941
+ EG
         3.23
                        IKF
                                  19
                        FC
+ XTI
         0
                                   0.5
+ TT
         0
                        BV
                                   1200
+ IBV
+ IAVE
         1.00E-03
                        VPK
                                   1200
          10
                         TYPE
                                  SiC PiN
.ENDS
* End of GB02SLT12-220 SPICE Model
```